![ANALOG DEVICES logo]

Dual 12-Bit *nano*DAC with ±10 ppm/°C On-Chip Reference

Enhanced Product

AD5623R-EP

FEATURES

Low power, smallest pin-compatible, dual *nano*DAC: 12 bits
User-selectable external or internal reference
    External reference default
    On-chip 2.5 V, ±10 ppm/°C reference
10-lead MSOP
4.5 V to 5.5 V power supply
Guaranteed monotonic by design
Power-on reset to zero scale
Per channel power-down
Serial interface up to 50 MHz
Hardware $\overline{LDAC}$ and $\overline{CLR}$ functions

ENHANCED PRODUCT FEATURES

Supports defense and aerospace applications (AQEC)
Extended temperature range: −55°C to +105°C
Controlled manufacturing baseline
One assembly/test site
One fabrication site
Enhanced product change notification
Qualification data available on request

APPLICATIONS

Process control
Data acquisition systems

GENERAL DESCRIPTION

The AD5623R-EP, a member of the *nano*DAC® family, is a low power, dual 12-bit buffered voltage output digital-to-analog converter (DAC) that operates from a single 4.5 V to 5.5 V supply and is guaranteed monotonic by design.

The AD5623R-EP has an on-chip 2.5 V reference giving a maximum full-scale output of 5 V. The on-chip reference is off at power-up, allowing the use of an external reference.

The AD5623R-EP incorporates a power-on reset circuit that ensures that the output of the DACs powers up to 0 V and remains there until a valid write takes place. The AD5623R-EP contains a power-down feature that reduces the current consumption of the device to 0.48 µA at 5 V and provides software-selectable output loads while in power-down mode.

The low power consumption of this device in normal operation makes it ideally suited to portable, battery-operated equipment.

The AD5623R-EP uses a versatile, 3-wire serial interface that operates at clock rates of up to 50 MHz, and is compatible with standard SPI, QSPI™, MICROWIRE™, and DSP interface standards. The on-chip precision output amplifier enables rail-to-rail output swing to be achieved. Additional application and technical information can be found in the AD5623R data sheet.

PRODUCT HIGHLIGHTS

1. Dual 12-Bit DAC.
2. On-Chip 2.5 V, ±10 ppm/°C Reference.
3. Available in 10-Lead MSOP.
4. Low Power. Typically consumes 1.25 mW at 5 V. 4.5 µs maximum settling time.

Table 1. Related Device

Part No.	Description
AD5623R	2.7 V to 5.5 V, dual 12-bit *nano*DAC, with external reference

FUNCTIONAL BLOCK DIAGRAM
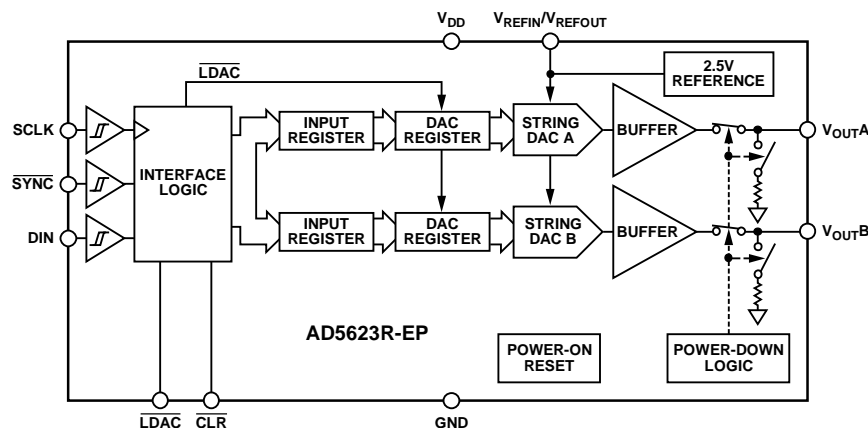
Figure 1.

Rev. A

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Technical Support   **www.analog.com**

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SPECIFICATIONS

V_{DD} = 4.5 V to 5.5 V; R_L = 2 kΩ to GND; C_L = 200 pF to GND; V_{REFIN}/V_{REFOUT} = V_{DD}; all specifications T_{MIN} to T_{MAX}, unless otherwise noted.

Table 2.

Parameter[1]	Min	Typ	Max	Unit	Test Conditions/Comments
STATIC PERFORMANCE[2]					
Resolution	12			Bits	
Relative Accuracy, INL		±1	±1.5	LSB	
Differential Nonlinearity, DNL			±1	LSB	Guaranteed monotonic by design
Zero-Scale Error		+2	+12	mV	All 0s loaded to DAC register
Offset Error		±1	±12	mV	
Full-Scale Error		−0.1	±1	% of FSR	All 1s loaded to DAC register
Gain Error			±1.5	% of FSR	
Zero-Scale Error Drift		±2		µV/°C	
Gain Temperature Coefficient		±2.5		ppm	Of FSR/°C
DC Power Supply Rejection Ratio		−100		dB	DAC code = midscale; V_{DD} = 5 V ± 10%
DC Crosstalk					
External Reference		10		µV	Due to full-scale output change; R_L = 2 kΩ to GND or V_{DD}
		10		µV/mA	Due to load current change
		5		µV	Due to powering down (per channel)
Internal Reference		25		µV	Due to full-scale output change; R_L = 2 kΩ to GND or V_{DD}
		20		µV/mA	Due to load current change
		10		µV	Due to powering down (per channel)
OUTPUT CHARACTERISTICS[3]					
Output Voltage Range	0		V_{DD}	V	
Capacitive Load Stability		2		nF	R_L = ∞
		10		nF	R_L = 2 kΩ
DC Output Impedance		0.5		Ω	
Short-Circuit Current		30		mA	V_{DD} = 5 V
Power-Up Time		4		µs	Coming out of power-down mode; V_{DD} = 5 V
REFERENCE INPUTS					
Reference Current		170	200	µA	V_{REFIN}/V_{REFOUT} = V_{DD} = 5.5 V
Reference Input Range	0.75		V_{DD}	V	
Reference Input Impedance		26		kΩ	
REFERENCE OUTPUT					
Output Voltage	2.495		2.505	V	At ambient
Reference Temperature Coefficient[3]		±10		ppm/°C	
Output Impedance		7.5		kΩ	
LOGIC INPUTS[3]					
Input Current			±2	µA	All digital inputs
Input Low Voltage (V_{INL})			0.8	V	V_{DD} = 5 V
Input High Voltage (V_{INH})	2			V	V_{DD} = 5 V
Pin Capacitance		3		pF	DIN, SCLK, and $\overline{SYNC}$
		19		pF	$\overline{LDAC}$ and $\overline{CLR}$
POWER REQUIREMENTS					
V_{DD}	4.5		5.5	V	
I_{DD} (Normal Mode)[4]					V_{INH} = V_{DD} and V_{INL} = GND
Internal Reference Off		0.25	0.45	mA	V_{DD} = 4.5 V to 5.5 V
Internal Reference On		0.8	1	mA	V_{DD} = 4.5 V to 5.5 V
I_{DD} (All Power-Down Modes)[5]		0.48	1	µA	V_{DD} = 4.5 V to 5.5 V, V_{INH} = V_{DD} and V_{INL} = GND

[1] Temperature range = −55°C to +105°C, typical at +25°C.
[2] Linearity calculated using a reduced code range: Code 32 to Code 4064. Output unloaded.
[3] Guaranteed by design and characterization, but not production tested.
[4] Interface inactive. All DACs active. DAC outputs unloaded.
[5] Both DACs powered down.

AC CHARACTERISTICS

V_{DD} = 4.5 V to 5.5 V; R_L = 2 kΩ to GND; C_L = 200 pF to GND; V_{REFIN}/V_{REFOUT} = V_{DD}; all specifications T_{MIN} to T_{MAX}, unless otherwise noted.

Table 3.

Parameter[1, 2]	Min	Typ	Max	Unit	Test Conditions/Comments
SLEW RATE		1.8		V/µs	
FEEDTHROUGH					
Digital Feedthrough		0.1		nV-sec	
Reference Feedthrough		−90		dB	V_{REFIN}/V_{REFOUT} = 2 V ± 0.1 V p-p, frequency 10 Hz to 20 MHz
CROSSTALK					
Digital Crosstalk		0.1		nV-sec	
Analog Crosstalk		1		nV-sec	External reference
		4		nV-sec	Internal reference
DAC-to-DAC Crosstalk		1		nV-sec	External reference
		4		nV-sec	Internal reference
MULTIPLYING BANDWIDTH		340		kHz	V_{REFIN}/V_{REFOUT} = 2 V ± 0.1 V p-p
TOTAL HARMONIC DISTORTION		−80		dB	V_{REFIN}/V_{REFOUT} = 2 V ± 0.1 V p-p, frequency = 10 kHz
OUTPUT CHARACTERISTICS					
Digital-to-Analog Glitch Impulse		10		nV-sec	1 LSB change around major carry
Output Voltage Settling Time		3	4.5	µs	¼ to ¾ scale settling to ±0.5 LSB
Output Noise Spectral Density		120		nV/√Hz	DAC code = midscale, 1 kHz
		100		nV/√Hz	DAC code = midscale, 10 kHz
Output Noise		15		µV p-p	0.1 Hz to 10 Hz

[1] Guaranteed by design and characterization, but not production tested.
[2] Temperature range = −55°C to +105°C, typical at +25°C.

TIMING CHARACTERISTICS

All input signals are specified with t_R = t_F = 1 ns/V (10% to 90% of V_{DD}) and timed from a voltage level of (V_{INL} + V_{INH})/2.
V_{DD} = 4.5 V to 5.5 V; all specifications T_{MIN} to T_{MAX}, unless otherwise noted.

Table 4.

Parameter[1]	Limit at T_{MIN}, T_{MAX}	Unit	Description
t_1[2]	20	ns min	SCLK cycle time
t_2	9	ns min	SCLK high time
t_3	9	ns min	SCLK low time
t_4	13	ns min	$\overline{SYNC}$ to SCLK falling edge setup time
t_5	5	ns min	Data setup time
t_6	5	ns min	Data hold time
t_7	0	ns min	SCLK falling edge to $\overline{SYNC}$ rising edge
t_8	15	ns min	Minimum $\overline{SYNC}$ high time
t_9	13	ns min	$\overline{SYNC}$ rising edge to SCLK fall ignore
t_{10}	0	ns min	SCLK falling edge to $\overline{SYNC}$ fall ignore
t_{11}	10	ns min	$\overline{LDAC}$ pulse width low
t_{12}	15	ns min	SCLK falling edge to $\overline{LDAC}$ rising edge
t_{13}	5	ns min	$\overline{CLR}$ pulse width low
t_{14}	0	ns min	SCLK falling edge to $\overline{LDAC}$ falling edge
t_{15}	300	ns max	$\overline{CLR}$ pulse activation time

[1] Guaranteed by design and characterization, but not production tested.
[2] Maximum SCLK frequency is 50 MHz at V_{DD} = 2.7 V to 5.5 V.

Timing Diagram

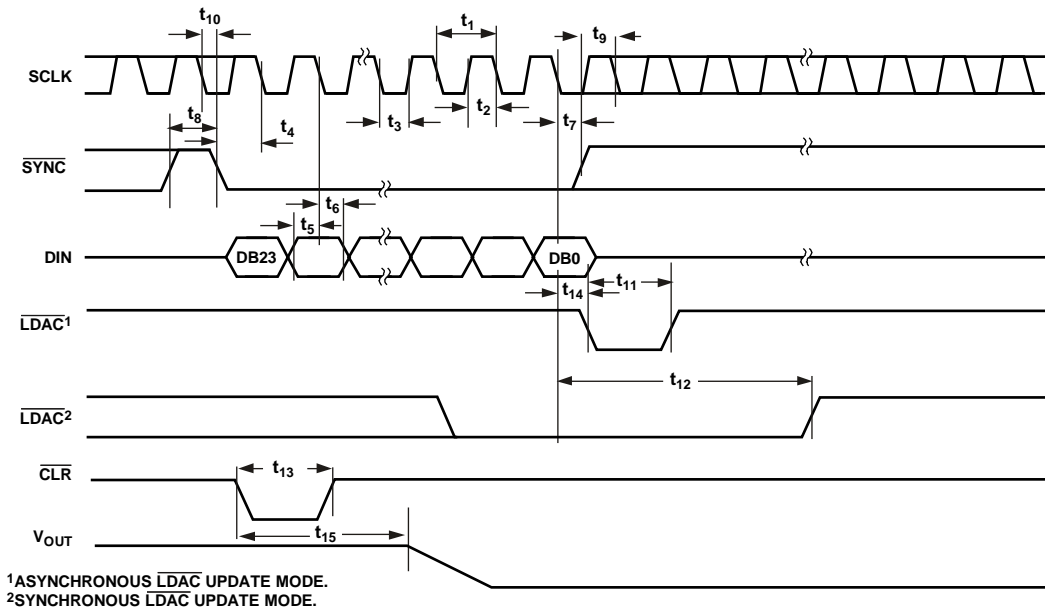[1]ASYNCHRONOUS $\overline{LDAC}$ UPDATE MODE.
[2]SYNCHRONOUS $\overline{LDAC}$ UPDATE MODE.

Figure 2. Serial Write Operation

ABSOLUTE MAXIMUM RATINGS

$T_A = 25°C$, unless otherwise noted.

Table 5.

Parameter	Rating
V_{DD} to GND	−0.3 V to +7 V
V_{OUTx} to GND	−0.3 V to V_{DD} + 0.3 V
V_{REFIN}/V_{REFOUT} to GND	−0.3 V to V_{DD} + 0.3 V
Digital Input Voltage to GND	−0.3 V to V_{DD} + 0.3 V
Operating Temperature Range	
Industrial	−55°C to +105°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature (T_J max)	150°C
Power Dissipation	(T_J max − T_A)/θ_{JA}
MSOP Package (4-Layer Board)	
θ_{JA} Thermal Impedance	142°C/W
θ_{JC} Thermal Impedance	43.7°C/W
Reflow Soldering Peak Temperature	
Pb-Free	260 (+0/−5)°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS
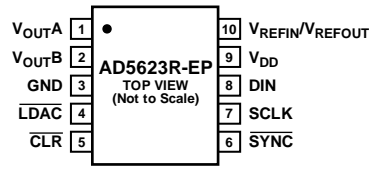
Figure 3. Pin Configuration

Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	$V_{OUT}A$	Analog Output Voltage from DAC A. The output amplifier has rail-to-rail operation.
2	$V_{OUT}B$	Analog Output Voltage from DAC B. The output amplifier has rail-to-rail operation.
3	GND	Ground. Reference point for all circuitry on the device.
4	$\overline{LDAC}$	Load DAC. Pulsing this pin low allows any or all DAC registers to be updated if the input registers have new data. This allows simultaneous update of all DAC outputs. Alternatively, this pin can be tied permanently low.
5	$\overline{CLR}$	Asynchronous Clear Input. The $\overline{CLR}$ input is falling edge sensitive. While $\overline{CLR}$ is low, all $\overline{LDAC}$ pulses are ignored. When $\overline{CLR}$ is activated, zero scale is loaded to all input and DAC registers. This clears the output to 0 V. The device exits clear code mode on the 24th falling edge of the next write to the device. If $\overline{CLR}$ is activated during a write sequence, the write is aborted.
6	$\overline{SYNC}$	Level-Triggered Control Input (Active Low). This is the frame synchronization signal for the input data. When $\overline{SYNC}$ goes low, it enables the input shift register, and data is transferred in on the falling edges of the following clocks. The DAC is updated following the 24th clock cycle unless $\overline{SYNC}$ is taken high before this edge, in which case the rising edge of $\overline{SYNC}$ acts as an interrupt and the write sequence is ignored by the DAC.
7	SCLK	Serial Clock Input. Data is clocked into the input shift register on the falling edge of the serial clock input. Data can be transferred at rates of up to 50 MHz.
8	DIN	Serial Data Input. This device has a 24-bit input shift register. Data is clocked into the register on the falling edge of the serial clock input.
9	V_{DD}	Power Supply Input. This device can be operated from 4.5 V to 5.5 V. Decouple the supply with a 10 µF capacitor in parallel with a 0.1 µF capacitor to GND.
10	V_{REFIN}/V_{REFOUT}	Common Reference Input/Reference Output. When the internal reference is selected, this is the reference output pin. When using an external reference, this is the reference input pin. The default for this pin is a reference input.

TYPICAL PERFORMANCE CHARACTERISTICS
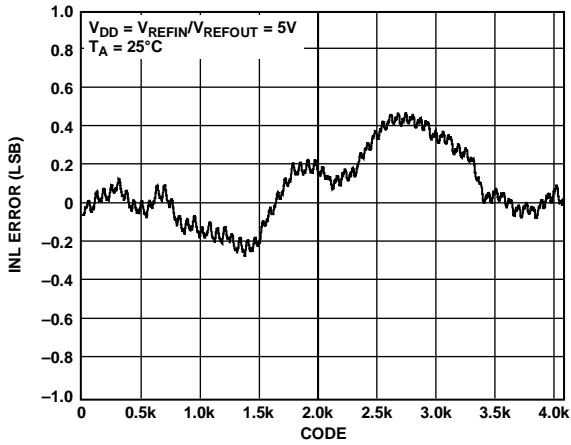
Figure 4. INL, External Reference
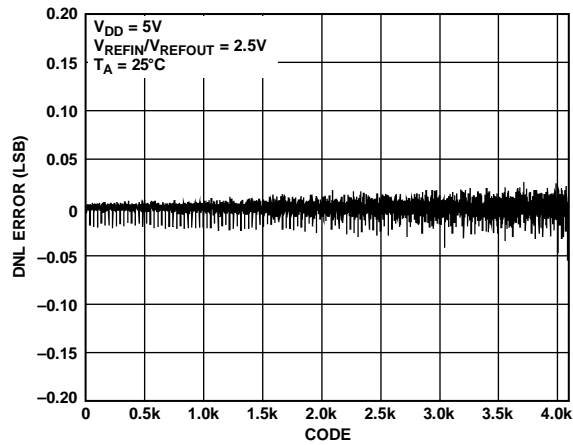
Figure 7. DNL, at 5 V V_{DD}
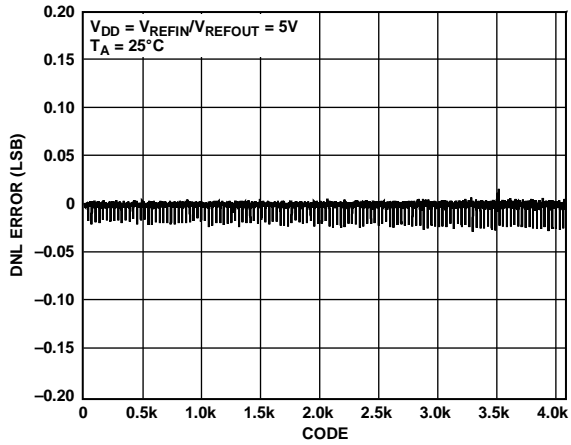
Figure 5. DNL, External Reference
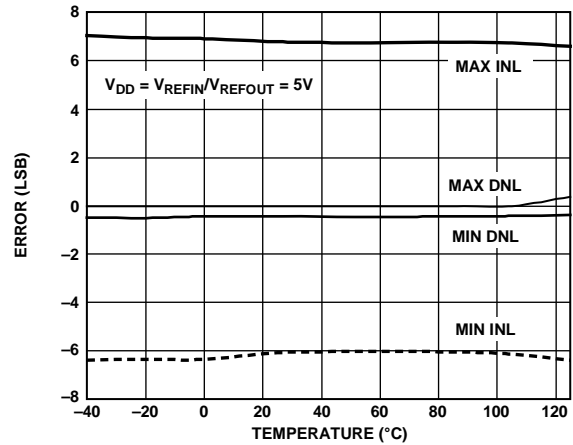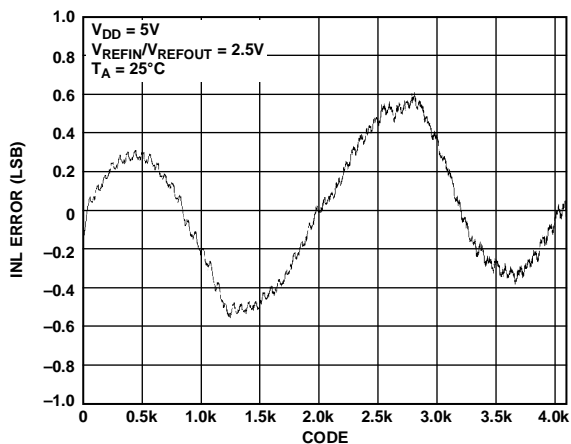

Figure 8. INL Error and DNL Error vs. Temperature

Figure 6. INL, at 5 V V_{DD}
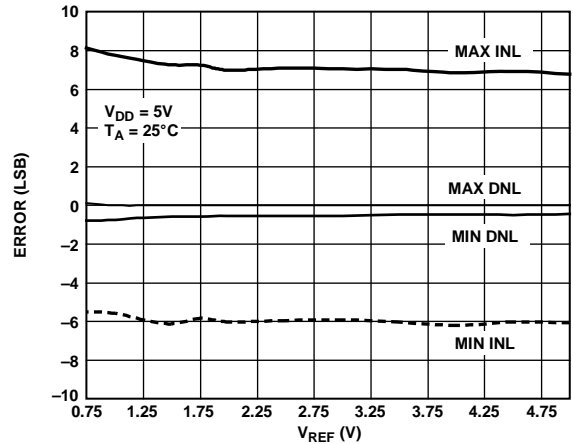
Figure 9. INL Error and DNL Error vs. V_{REF}

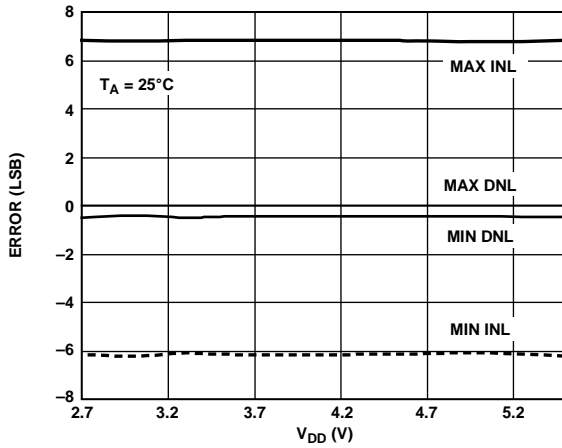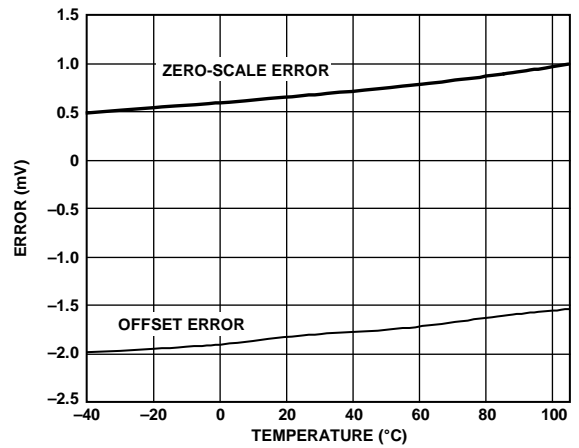*Figure 10. INL Error and DNL Error vs. V_{DD}*

Figure 11. Gain Error and Full-Scale Error vs. Temperature

Figure 12. Gain Error and Full-Scale Error vs. V_{DD}

Figure 13. Zero-Scale Error and Offset Error vs. Temperature

Figure 14. Zero-Scale Error and Offset Error vs. V_{DD}
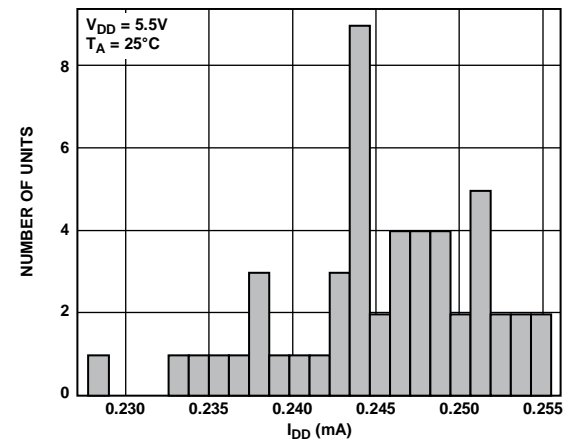
Figure 15. I_{DD} Histogram with External Reference
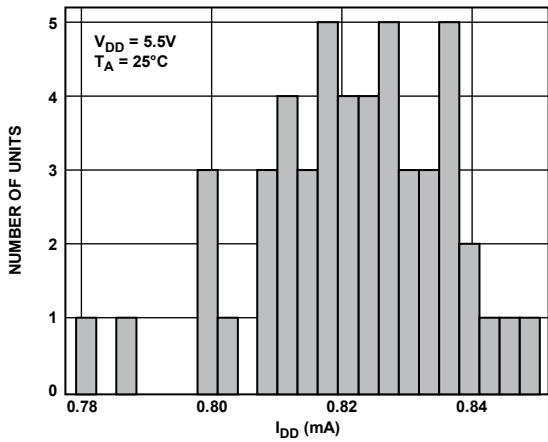
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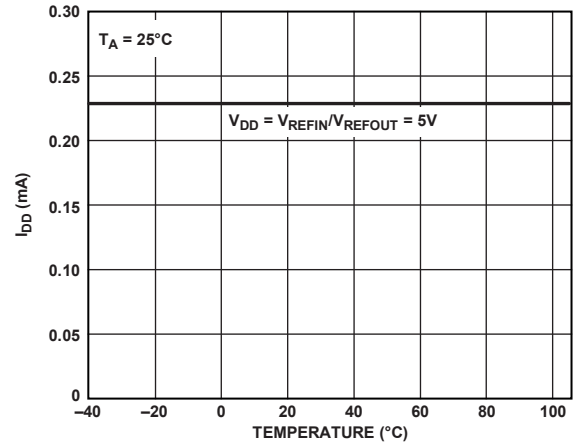
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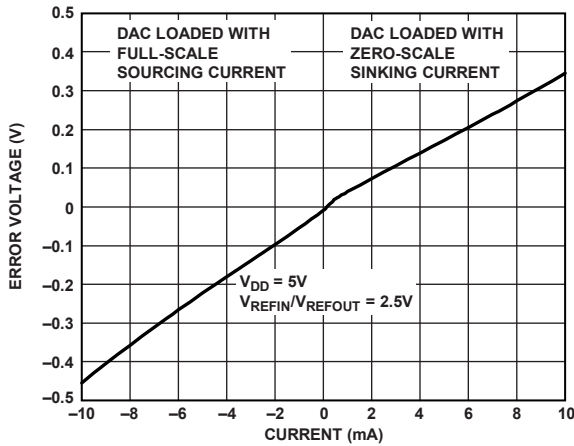
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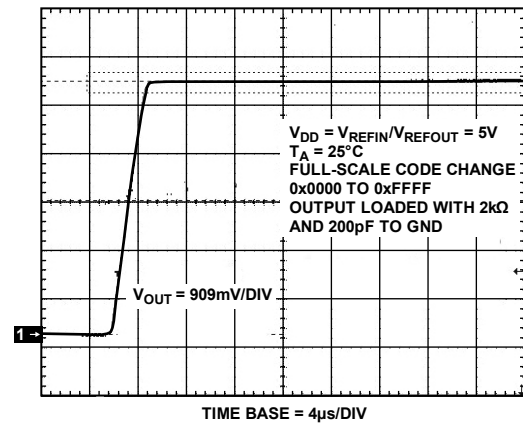
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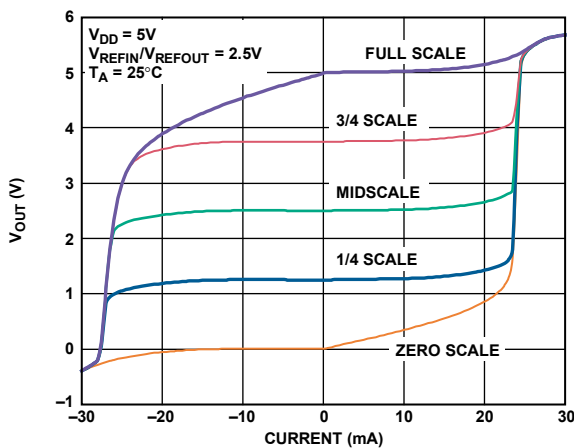
Figure 18. 5 V V_{DD} Source and Sink Capability
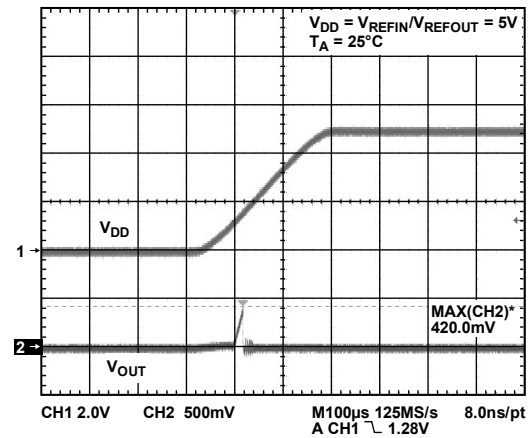
Figure 21. Power-On Reset to 0 V
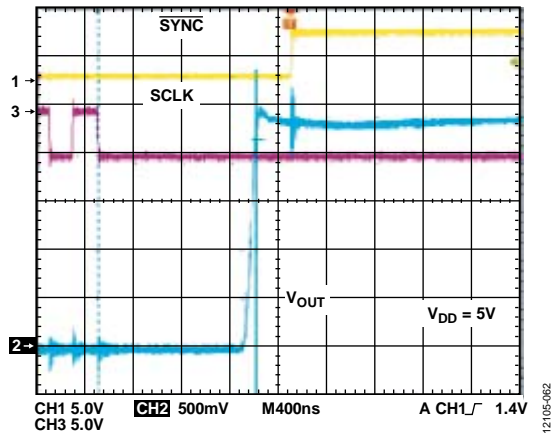
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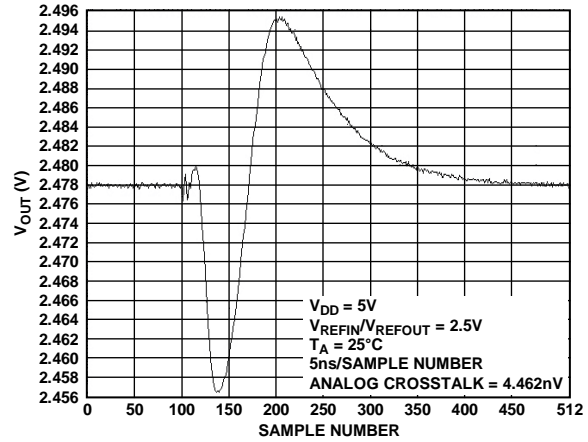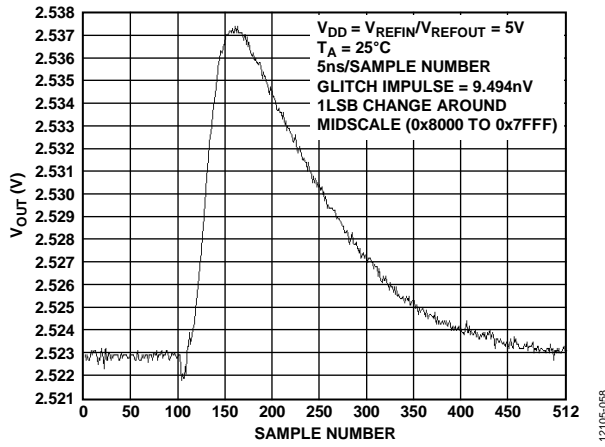

Figure 25. Analog Crosstalk, Internal Reference
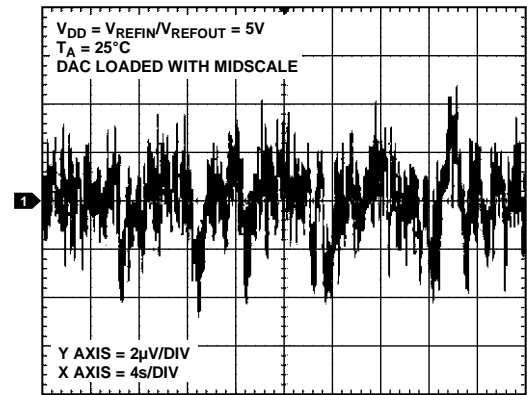

Figure 23. Digital-to-Analog Glitch Impulse (Negative)

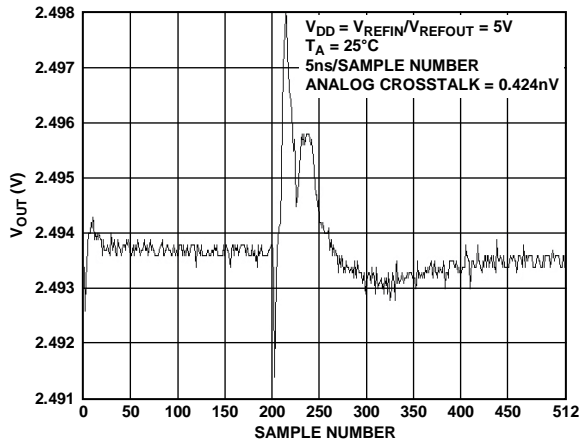Figure 26. 0.1 Hz to 10 Hz Output Noise Plot, External Reference

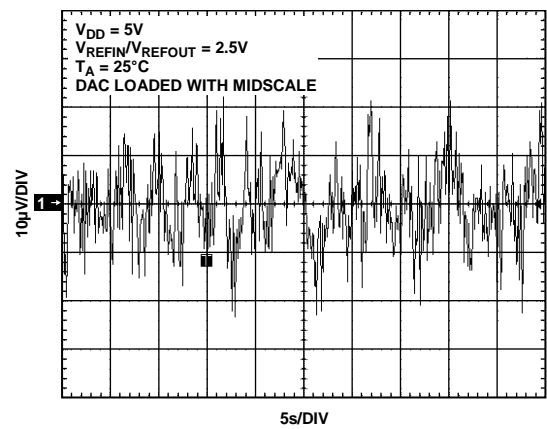Figure 24. Analog Crosstalk, External Reference

Figure 27. 0.1 Hz to 10 Hz Output Noise Plot, Internal Reference
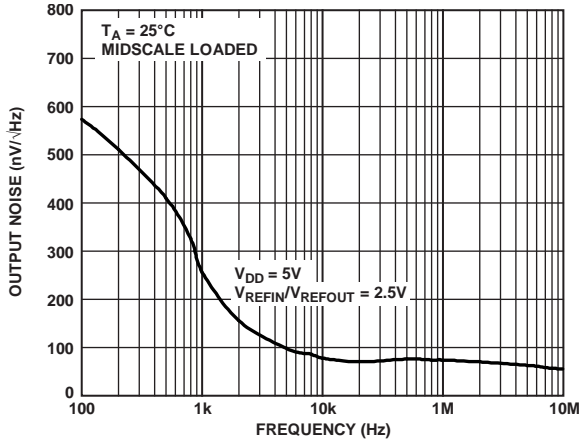
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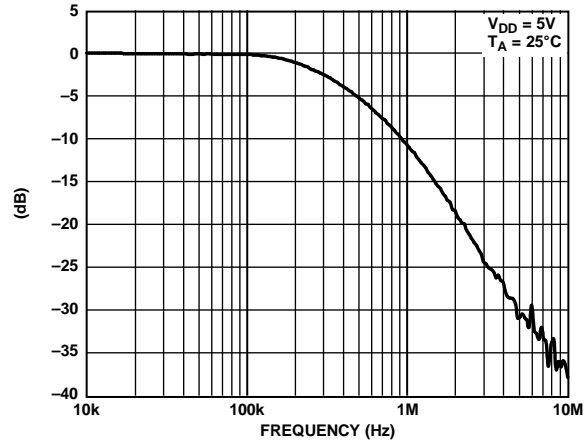Figure 28. Noise Spectral Density, Internal Reference

Figure 31. Multiplying Bandwidth
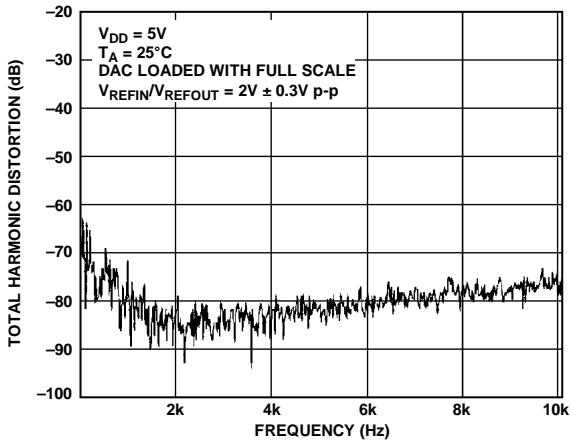
Figure 29. Total Harmonic Distortion

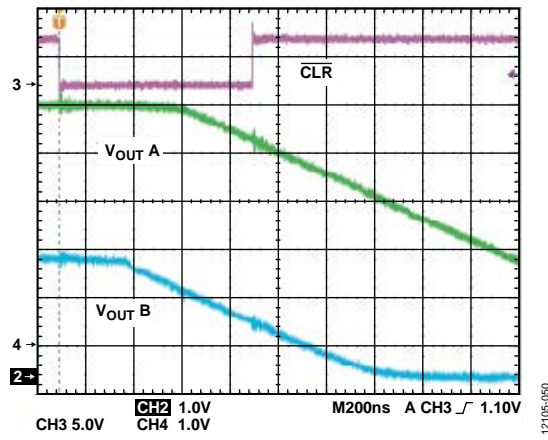Figure 32. $\overline{CLR}$ Pulse Activation Time
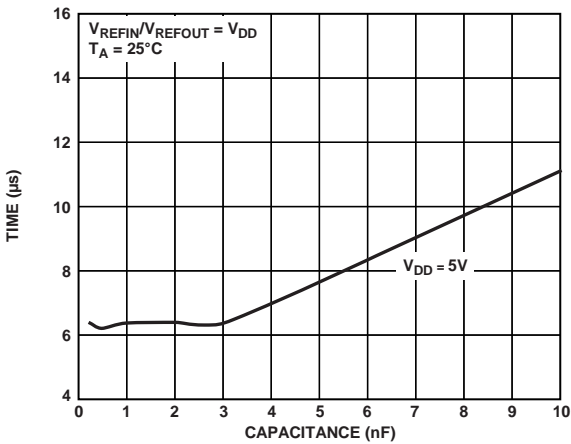
Figure 30. Settling Time vs. Capacitive Load

APPLICATIONS INFORMATION

USING A REFERENCE AS A POWER SUPPLY

Because the supply current required by the AD5623R-EP is extremely low, an alternative option is to use a voltage reference to supply the required voltage to the device (see Figure 33). This is especially useful if the power supply is quite noisy or if the system supply voltages are at some value other than 5 V or 3 V, for example, 15 V. The voltage reference outputs a steady supply voltage for the AD5623R-EP. If the ADR293-EP is used, it must supply ~500 µA of current to the AD5623R-EP, with no load on the output of the DAC. When the DAC output is loaded, the ADR293-EP also needs to supply the current to the load. The total current required (with a 5 kΩ load on the DAC output) is

$$500\ \mu A + (5\ V/5\ k\Omega) = 1.5\ mA$$

The load regulation of the ADR293-EP is typically 30 ppm/mA, which results in a 45 ppm (225 µV) error for the 1.5 mA current drawn from it. This corresponds to a 0.184 LSB error.
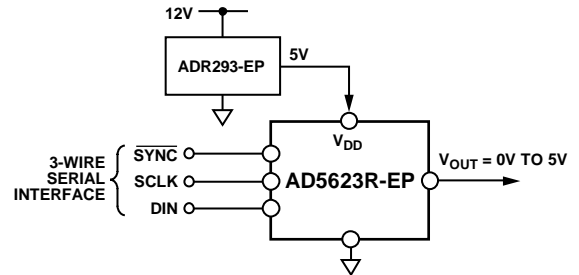

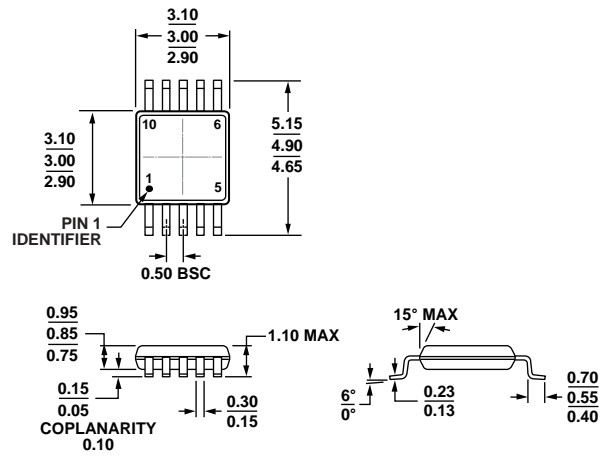Figure 33. ADR293-EP as Power Supply to the AD5623R-EP

OUTLINE DIMENSIONS

COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 34. 10-Lead Mini Small Outline Package [MSOP]
(RM-10)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Accuracy	Internal Reference	Package Description	Package Option	Branding
AD5623RSRMZ-EP-5R7	−55°C to +105°C	±1.5 LSB INL	2.5 V	10-Lead MSOP	RM-10	DN9

[1] Z = RoHS Compliant Part.

NOTES

NOTES

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